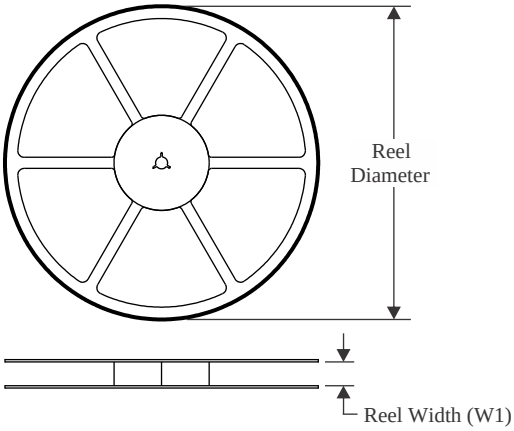
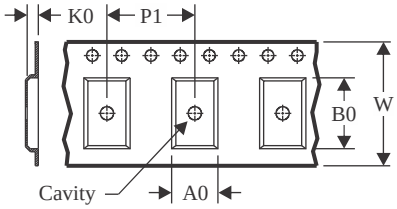
TAPE AND REEL INFORMATION

REEL DIMENSIONS

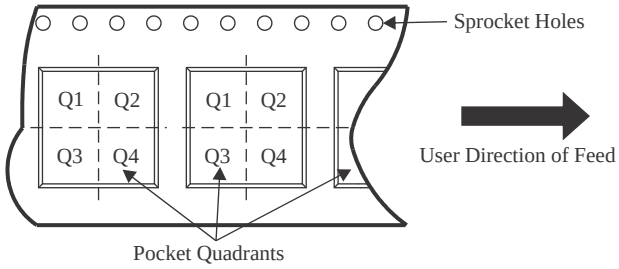


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

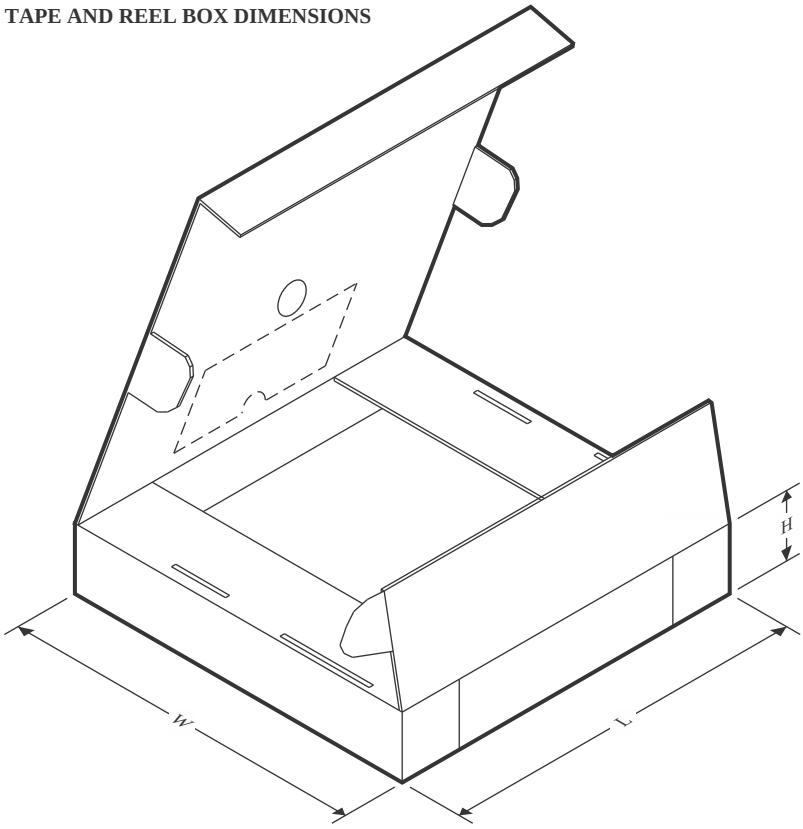
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2574HVMX-12/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574HVMX-15/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574HVMX-3.3/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574HVMX-5.0/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574HVMX-ADJ/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574MX-12/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574MX-3.3/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574MX-5.0/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1
LM2574MX-ADJ/NOPB	SOIC	NPA	14	1000	330.0	16.4	10.9	9.5	3.2	12.0	16.0	Q1

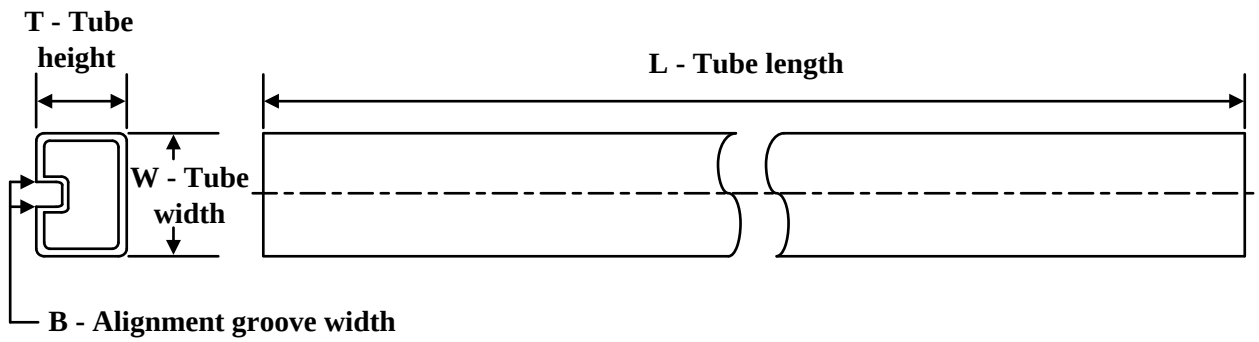
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2574HVMX-12/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574HVMX-15/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574HVMX-3.3/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574HVMX-5.0/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574HVMX-ADJ/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574MX-12/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574MX-3.3/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574MX-5.0/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0
LM2574MX-ADJ/NOPB	SOIC	NPA	14	1000	356.0	356.0	36.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LM2574HVM-12/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-12/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-15/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-15/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-3.3/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-3.3/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-5.0/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-5.0/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-ADJ/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVM-ADJ/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574HVN-12/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-12/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-15/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-15/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-5.0/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-5.0/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-ADJ/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574HVN-ADJ/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574M-12/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-12/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-3.3/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-3.3/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-5.0/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-5.0/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-ADJ/NOPB	NPA	SOIC	14	50	495	15	5842	7.87
LM2574M-ADJ/NOPB.B	NPA	SOIC	14	50	495	15	5842	7.87
LM2574N-12/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574N-12/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574N-3.3/NOPB	P	PDIP	8	40	502	14	11938	4.32

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LM2574N-3.3/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574N-5.0/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574N-5.0/NOPB.B	P	PDIP	8	40	502	14	11938	4.32
LM2574N-ADJ/NOPB	P	PDIP	8	40	502	14	11938	4.32
LM2574N-ADJ/NOPB.B	P	PDIP	8	40	502	14	11938	4.32